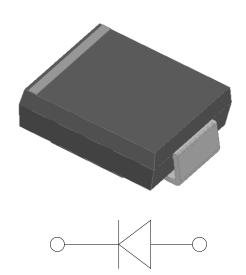




Surface Mount Ultrafast Rectifier Diode



Features

- Ultrafast reverse recovery time
- Low leakage current
- Low switching losses, high efficiency
- High forward surge capability
- Solder dip 260 °C max. 10 s, per JESD 22-B106

Typical Applications

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

Mechanical Data

• Package: DO-214AB (SMC)

Molding compound meets UL 94 V-0 flammability rating,

RoHS-compliant

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

• Polarity: Color band denotes the cathode end

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MURS360
Device marking code			MURS360
Repetitive Peak Reverse Voltage	V_{RRM}	V	600
Average Rectified Output Current @60Hz sine wave, Resistance load, Ta (FIG.1)	Io	А	3.0
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Ta=25℃	I _{FSM}	А	100
Storage Temperature	T _{stg}	°C	-55 ~+150
Junction Temperature	Tj	°C	-55 ~+150

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	MURS360
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =3.0A	1.25
Maximum reverse recovery time	T_RR	ns	I _F =0.5A,IR=1.0A, Irr=0.25A	50
Maximum DC reverse current at rated DC blocking voltage per diode	I _R		Ta=25℃	5
		μΑ	Ta=125℃	50

MURS360

■Thermal Characteristics (Ta=25°C Unless otherwise specified)

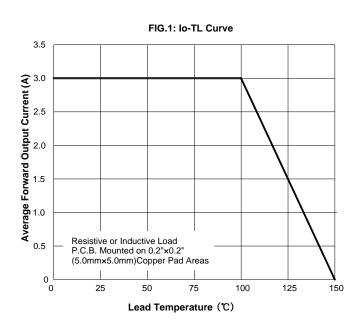
PARAMETER		SYMBOL	UNIT	MURS360
Thermal Resistance	Junction to ambient	$R_{\theta J-A}$	°C/W	48 ¹⁾
	Junction to lead	$R_{\theta J-L}$		14 ¹⁾

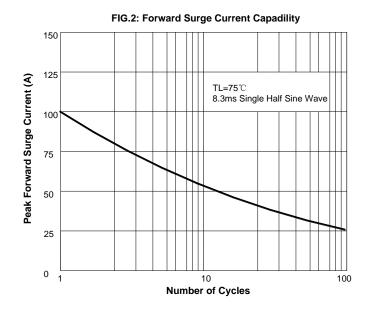
Note(1)

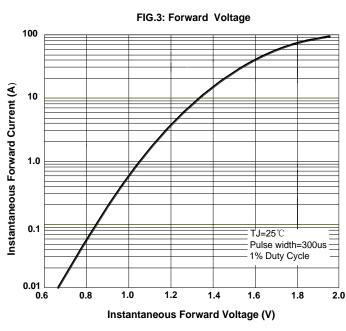
■Ordering Information (Example)

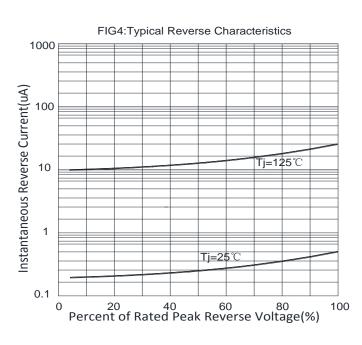
PREFERED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
MURS360	F1	Approximate 0.248	3000	6000	42000	13" reel

■ Characteristics(Typical)







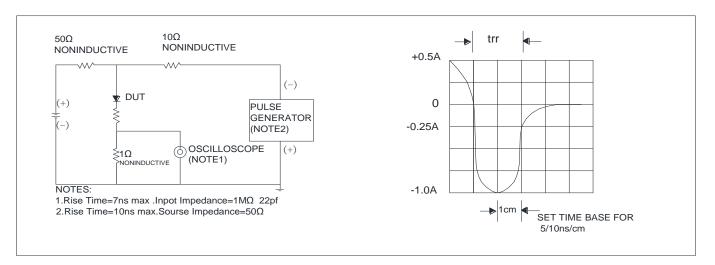


2/4

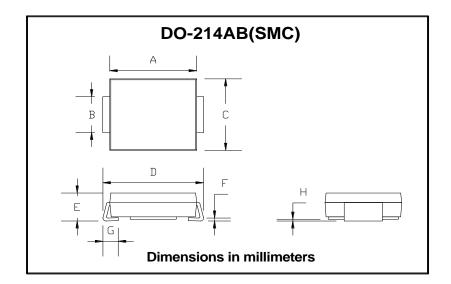
Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas



FIG.5: Diagram of circuit and Testing wave form of reverse recovery time

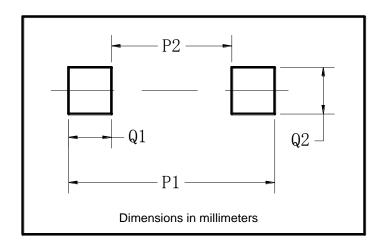


■ Outline Dimensions



DO-214AB (SMC)			
Dim	Min	Max	
Α	6.60	7.11	
В	2.85	3.27	
С	5.59	6.22	
D	7.75	8.13	
E	1.99	2.61	
F	0.15	0.31	
G	0.76	1.52	
Н	0.10	0.20	

■ Suggested pad layout



Dim	Тур
P1	9.9
P2	3.84
Q1	3.03
Q2	3.82



MURS360

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